STEFANO LARENTIS

Website: stefanolarentis.github.io

stefano.larentis@gmail.com ● (512) 983-7698 Italian Citizen – F-1 Visa Holder eligible for OPT

Objective: Seeking a process integration, device, yield, reliability engineer position in the semiconductor industry.

EDUCATION

University of Texas at Austin, Austin, TX

08/2011 - expected 08/2018

Ph.D., Electrical Engineering Track: Solid-State Electronics

GPA: 4.0/4.0

Politecnico di Milano, Milan, Italy

09/2009 – 07/2011

M.S., Electronic Engineering Track: Solid-State Electronics

GPA: 28.2/30.0

Politecnico di Milano, Milan, Italy

09/2006 – 07/2009

B.S., Electronic Engineering *summa cum Laude*

GPA: 28.9/30.0

RESEARCH EXPERIENCE (GOOGLE SCHOLAR)

University of Texas at Austin, Microelectronic Research Center, **Prof. Emanuel Tutuc** National High Magnetic Field Laboratory, Tallahassee, FL – **Visiting researcher**

01/2012 – Present 11/2016, 04/2017, 09/2017

- Developed state of the art transfer techniques to fabricate all-2D material heterostructures, an analogue to epitaxy. Designed *transition metal dichalcogenides* (TMDs) FETs process flow. Integrated dual-gated TMD FETs fully encapsulated in hBN dielectric using a bottom contact architecture to obtain *low resistance contacts*.
- Investigated TMDs (MoS₂, MoSe₂, MoTe₂) electron transport, measuring *mobility temperature dependence* and characterizing scattering mechanisms. Introduced a novel method to measure *TMDs band offset*, using a graphene heterostructure. Conducted magnetotransport studies to probe TMDs' *bandstructure* (determined *electron m**, valley population) quantum Hall effect and electron-electron interaction (*negative capacitance*).
- <u>S. Larentis</u>, H. C. P. Movva, K. Kim, B. Fallahazad, A. Behroozi, S. K. Banerjee, and E. Tutuc, *Large effective mass and interaction-enhanced Zeeman splitting of K-valley electrons in MoSe*₂, Under review (2018)
- <u>S. Larentis</u>, B. Fallahazad, H. C. P. Movva, K. Kim, A. Rai, T. Taniguchi, K. Watanabe, S. K. Banerjee, and E. Tutuc, *Reconfigurable Complementary Monolayer MoTe₂ Field-Effect Transistors for Integrated Circuits*, ACS Nano (2017)
- <u>S. Larentis</u>, J. R. Tolsma, B. Fallahazad, D. C. Dillen, K. Kim, A. H. MacDonald and E. Tutuc, *Band Offset and Negative Compressibility in Graphene-MoS₂ Heterostructures*, Nano Lett. 14 (4), 2039, (2014)
- <u>S. Larentis</u>, B. Fallahazad and E. Tutuc, *Field-effect transistors and intrinsic mobility in ultra-thin MoSe₂ layers,* Appl. Phys. Lett., 101, 223104, (2012)

Politecnico di Milano, Department of Electronics, Prof. Daniele Ielmini

09/2010 - 08/2011

- Performed NVM cell electrical characterization (DC, pulsed) for unipolar (NiO_x) and bipolar (HfO_x) RRAMs.
- Developed resistive switching electro-thermal models, using finite-element methods, describing set, reset, multi-level operation and retention, allowing for scaling/reliability projections and disturb extrapolation.
- <u>S. Larentis</u>, F. Nardi, S. Balatti, D. C. Gilmer, and D. Ielmini, *Resistive Switching by Voltage-Driven Ion Migration in Bipolar RRAM—Part II: Modeling*, IEEE Trans. on Electron Devices, 59, (9), 2468, (2012) (<u>Video</u>)
- <u>S. Larentis</u>, C. Cagli, F. Nardi, D. Ielmini, *Filament diffusion model for simulating reset and retention processes in RRAM,* Microelectron. Eng., 88 (7), 1119, (2011)

SKILLS AND AWARDS

Semiconductor and Device Physics, Device Fabrication: (e-beam) lithography, dry/wet etch, e-beam evaporation, sputtering, ellipsometry, ALD and oxide growth, optical (laser) microscopy. Maintained a custom UHV annealing tool; Material Characterization: AFM, SEM, XRD, Raman and Photoluminescence; Device Characterization: parameter analyzer, lock-in, capacitance bridge measurements in probe-stations & cryostats at low temperatures (1.4 K) and high magnetic fields (35 T); pulsed measurements (oscilloscope and signal generator); Modeling and Simulations: Matlab, Comsol, Mathematica, C/C++; Data Analysis: Origin; Hardware Interface: LabView, Layout CAD; Team Work: supervised 6 undergraduate and junior graduate students, teaching assistant for three different EE upper division undergraduate classes; Vendor Relationship: selected and ordered equipment worth >\$100K.

• TECHCON 2014, Best in Session Av	ward, Austin, TX • INFOS 20	11, Best Student Paper Awa	ard, Grenoble, France